

2SJ247

Silicon P Channel MOS FET

Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V Gate drive device can be driven from 5 V source
- Suitable for Switching regulator, DC – DC converter

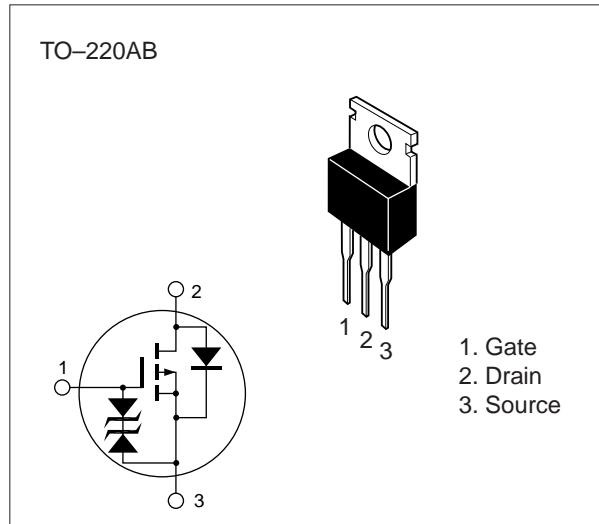


Table 1 Absolute Maximum Ratings (Ta = 25°C)

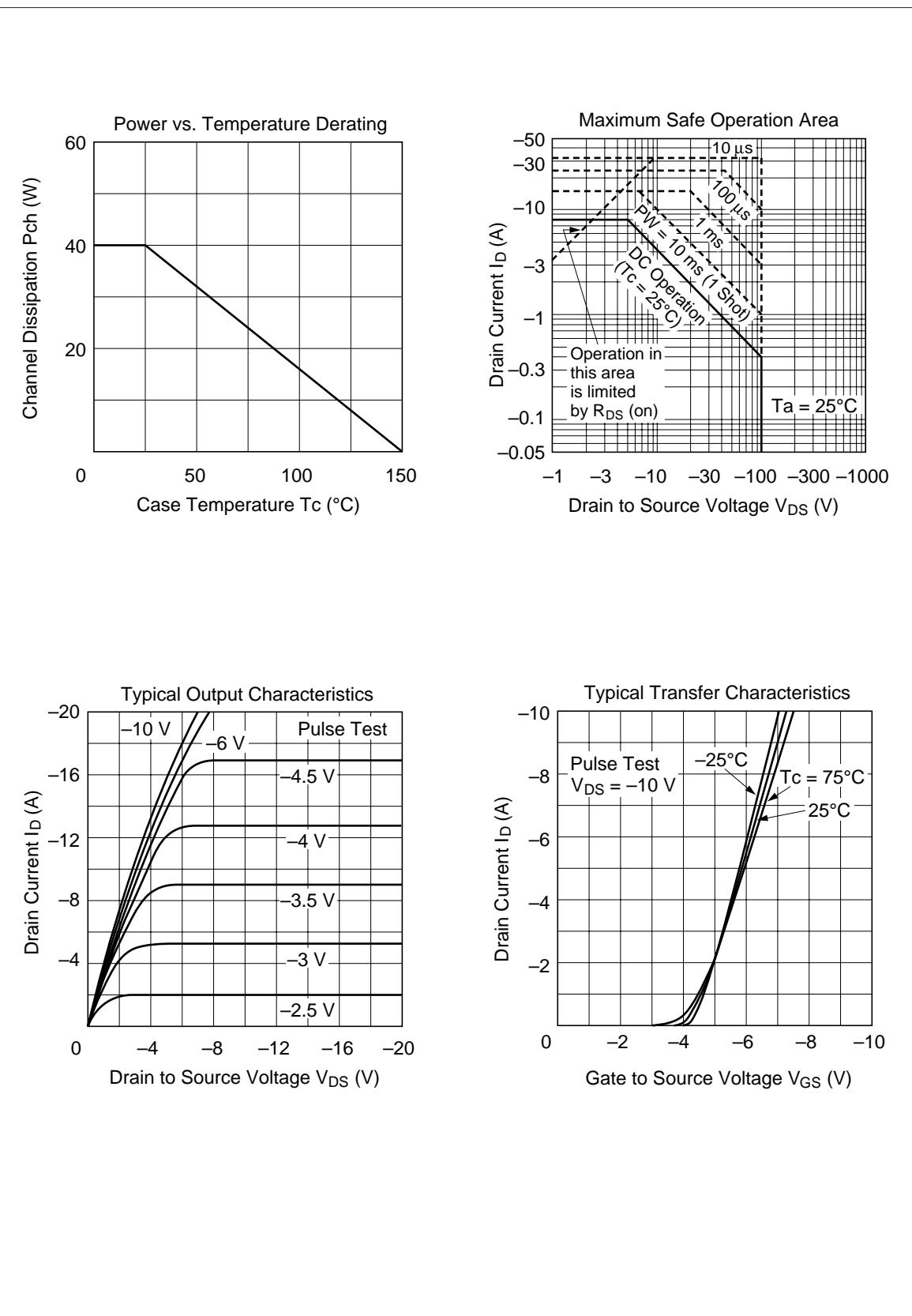
| Item | Symbol | Ratings | Unit |
|--|-------------------------|-------------|------|
| Drain to source voltage | V _{DSS} | -100 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | -8 | A |
| Drain peak current | I _{D(pulse)} * | -32 | A |
| Body-drain diode reverse drain current | I _{DR} | -8 | A |
| Channel dissipation | P _{ch} ** | 40 | W |
| Channel temperature | T _{ch} | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

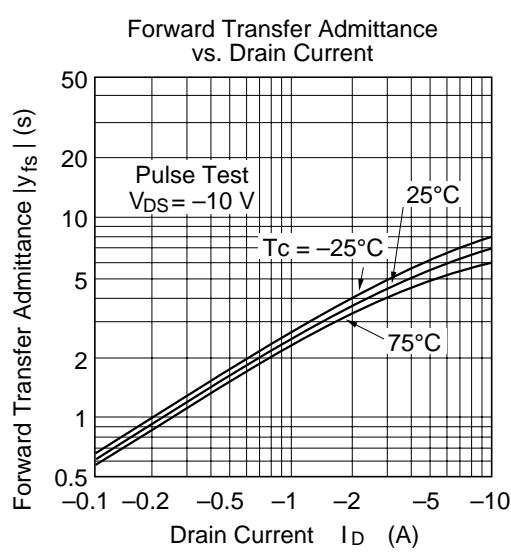
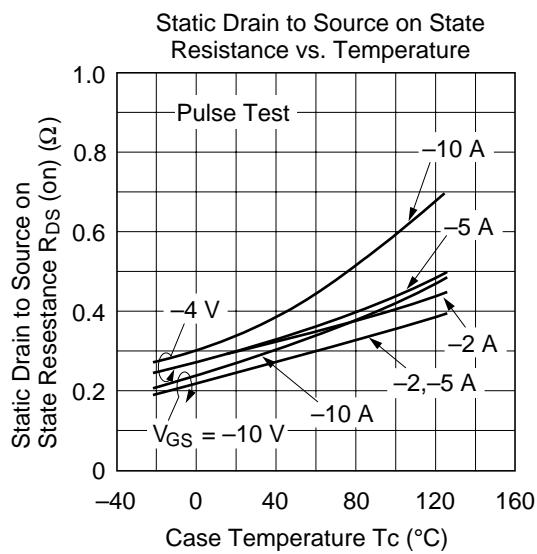
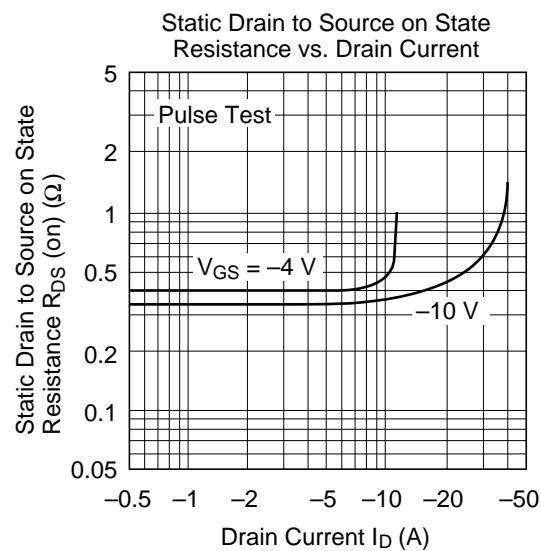
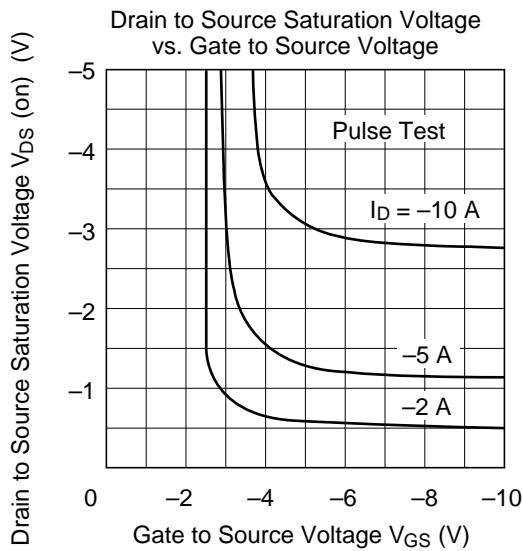
* PW ≤ 10 µs, duty cycle ≤ 1 %

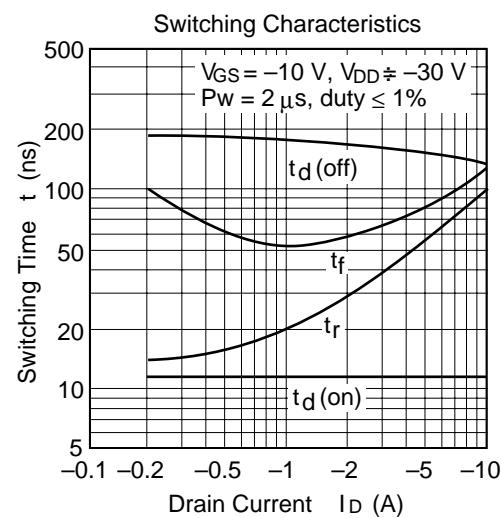
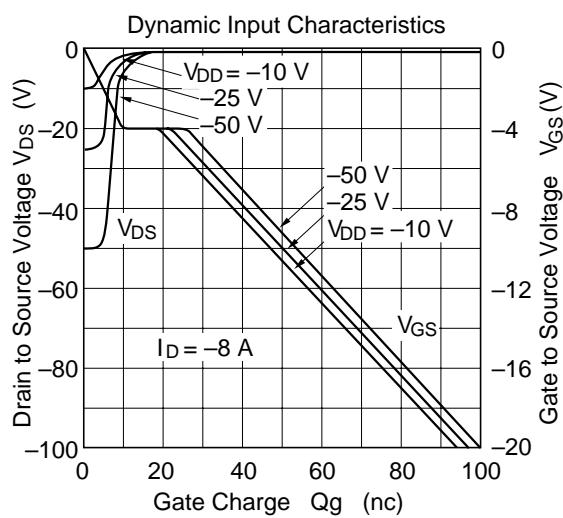
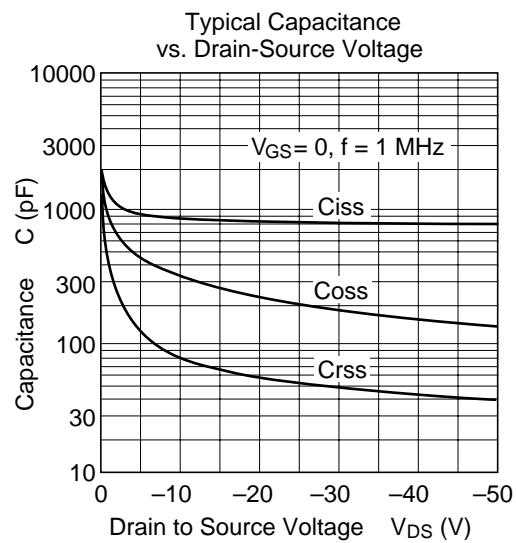
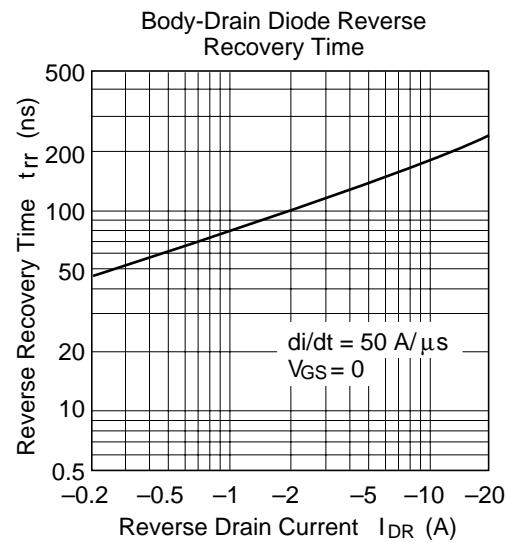
** Value at T_c=25°C

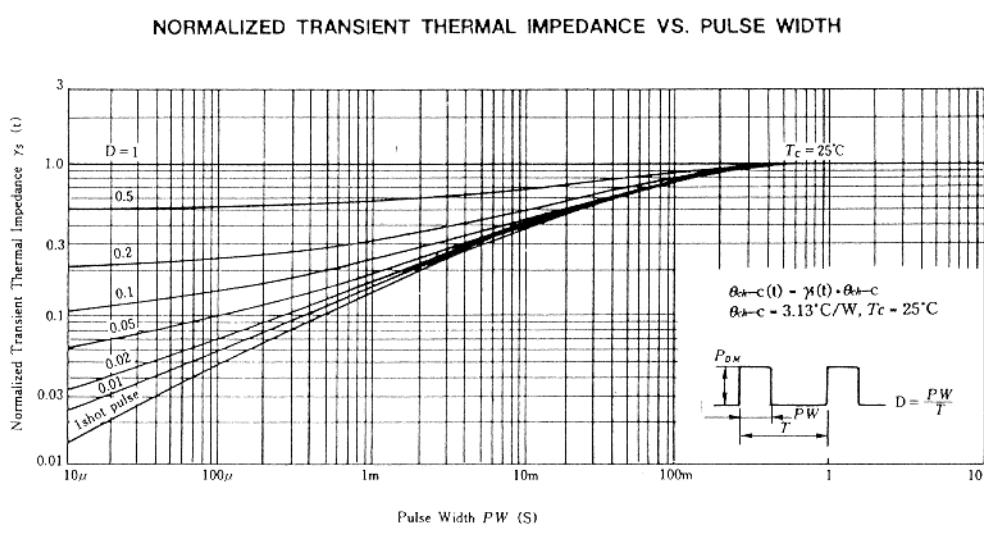
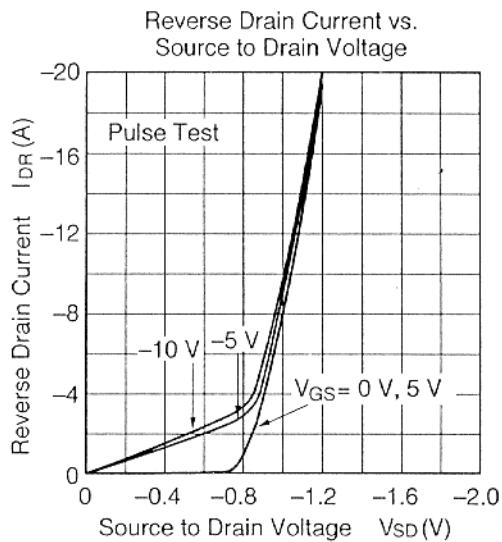
Table 2 Electrical Characteristics (Ta = 25°C)

| Item | Symbol | Min | Typ | Max | Unit | Test conditions |
|--|----------------------|------|------|------|------|---|
| Drain to source breakdown voltage | V _{(BR)DSS} | -100 | — | — | V | I _D = -10 mA, V _{GS} = 0 |
| Gate to source breakdown voltage | V _{(BR)GSS} | ±20 | — | — | V | I _G = ±100 µA, V _{DS} = 0 |
| Gate to source leak current | I _{GSS} | — | — | ±10 | µA | V _{GS} = ±16 V, V _{DS} = 0 |
| Zero gate voltage drain current | I _{DSS} | — | — | -250 | µA | V _{DS} = -80 V, V _{GS} = 0 |
| Gate to source cutoff voltage | V _{GS(off)} | -1.0 | — | -2.0 | V | I _D = -1 mA, V _{DS} = -10 V |
| Static drain to source on state resistance | R _{DS(on)} | — | 0.25 | 0.3 | Ω | I _D = -4 A V _{GS} = -10 V * |
| | | — | 0.3 | 0.45 | Ω | I _D = -4 A V _{GS} = -4 V * |
| Forward transfer admittance | y _{fs} | 3.0 | 5.5 | — | S | I _D = -4 A V _{DS} = -10 V * |
| Input capacitance | C _{iss} | — | 880 | — | pF | V _{DS} = -10 V |
| Output capacitance | C _{oss} | — | 325 | — | pF | V _{GS} = 0 |
| Reverse transfer capacitance | C _{rss} | — | 80 | — | pF | f = 1 MHz |
| Turn-on delay time | t _{d(on)} | — | 12 | — | ns | I _D = -4 A |
| Rise time | t _r | — | 47 | — | ns | V _{GS} = -10 V |
| Turn-off delay time | t _{d(off)} | — | 150 | — | ns | R _L = 7.5 Ω |
| Fall time | t _f | — | 75 | — | ns | |
| Body-drain diode forward voltage | V _{DF} | — | -1.0 | — | V | I _F = -8 A, V _{GS} = 0 |
| Body-drain diode reverse recovery time | t _{rr} | — | 170 | — | ns | I _F = -8 A, V _{GS} = 0, dI _F / dt = 50 A / µs |

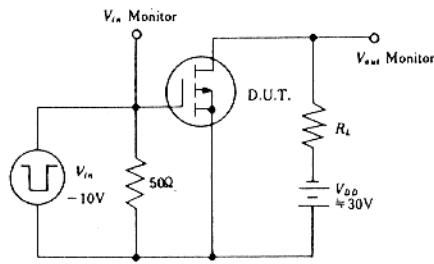








SWITCHING TIME TEST CIRCUIT



WAVEFORMS

